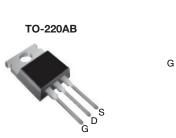


ROHS COMPLIANT



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.10				
Q <sub>g</sub> max. (nC)	25				
Q <sub>gs</sub> (nC)	5.8				
Q <sub>gd</sub> (nC)	11				
Configuration	Single				



S

N-Channel MOSFET

### FEATURES

- Dynamic dV/dt rating
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFZ24PbF			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	60	Ň	
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		17		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	12	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	68	1	
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	100	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	60	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	*0	
Soldering Recommendations (Peak temperature) <sup>d</sup>	) <sup>d</sup> for 10 s		-	300	- °C	
Mounting Torque	6.00 or	0.00 140		10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 403 µH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 17 A (see fig. 12).
- c.  $I_{SD} \le 17$  A, dI/dt  $\le 140$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.

d. 1.6 mm from case.

1 For technical questions, contact: <u>hvm@vishay.com</u>



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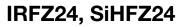
THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	2.5	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.061	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> :	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		-	25	
Zero Gale Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 10 A <sup>b</sup>	-	-	0.10	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 25 V, I <sub>D</sub> = 10 A	5.5	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	640	-	pF
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 V,$	-	360	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	.0 MHz, see fig. 5	-	79	-	
Total Gate Charge	Qg			-	-	25	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	5.8	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	-	11	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 30 V, I <sub>D</sub> = 17 A, R <sub>g</sub> = 18 $\Omega$ , R <sub>D</sub> = 1.7 $\Omega$ , see fig. 10 <sup>b</sup>		-	13	-	- ns
Rise Time	t <sub>r</sub>			-	58	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	25	-	
Fall Time	t <sub>f</sub>			-	42	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s				•		
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	17	А
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	68	А
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 17 A, $V_{\rm GS}$ = 0 V <sup>b</sup>		-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	тосоо	17 0 -11/-14 100 0 / -	-	88	180	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 17 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		-	0.29	0.64	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )				Ln)	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 





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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

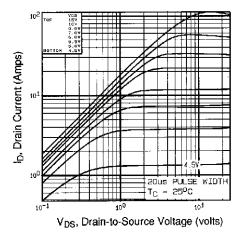


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C



Fig. 2 - Typical Output Characteristics,  $T_C = 175 \ ^\circ C$ 

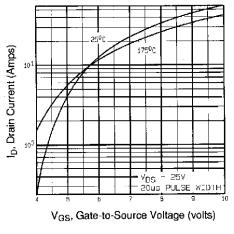


Fig. 3 - Typical Transfer Characteristics

S16-0013-Rev. C, 18-Jan-16

3.0 = 17A R<sub>DS(ON)</sub>, Drain-to-Source On Resistance IJ 2.5 2.0 (Normalized) 1. С. /GS = 10\ 6.0 B0 100 120 140 160 180 -20 0 20 40 60 -60 -40 T<sub>.b</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

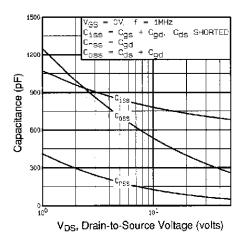
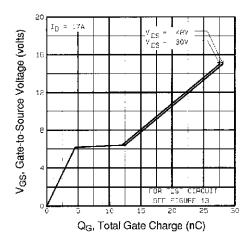


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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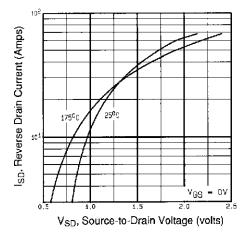


Fig. 7 - Typical Source-Drain Diode Forward Voltage

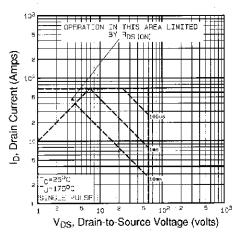
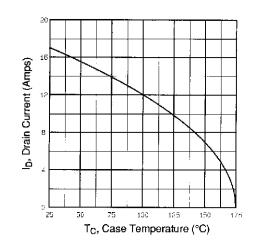


Fig. 8 - Maximum Safe Operating Area



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Fig. 9 - Maximum Drain Current vs. Case Temperature

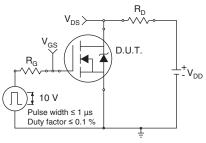


Fig. 10a - Switching Time Test Circuit

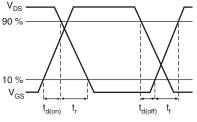
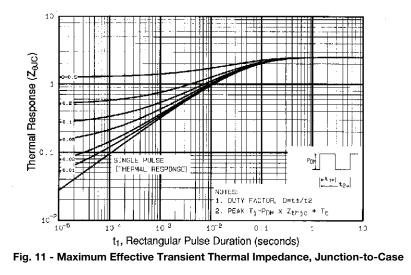


Fig. 10b - Switching Time Waveforms



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4

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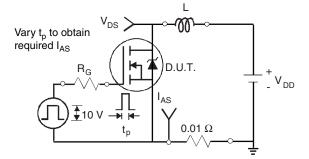
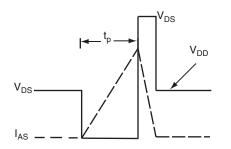


Fig. 12a - Unclamped Inductive Test Circuit



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Fig. 12b - Unclamped Inductive Waveforms

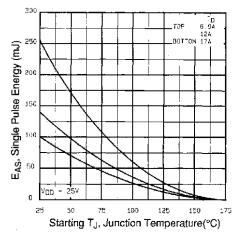


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

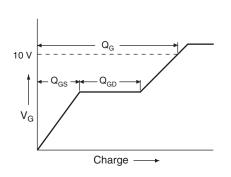


Fig. 13a - Basic Gate Charge Waveform

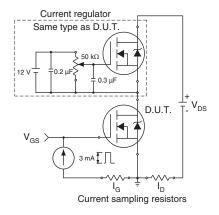


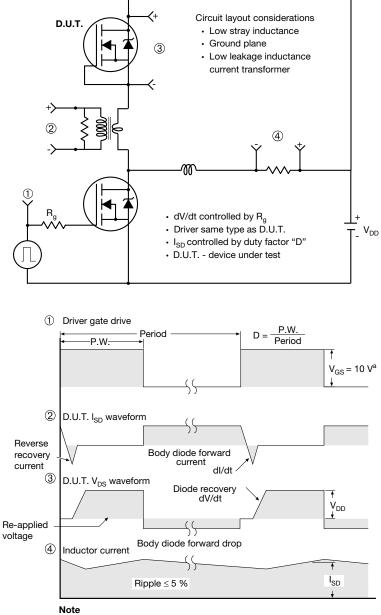
Fig. 13b - Gate Charge Test

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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN. MAX.		MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
AS	ASE		'an	
		IRF 9510 744K AB		

Revison: 14-Dec-15

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